Preliminary

TLRH50T(F),TLSH50T(F),TLOH50T(F),TLYH50T(F)

• This material is technological examination material to aim at the product introduction. The change in the content of the characteristic might be accompanied at the final specification process. The final specification will be able to be gotten in the brokerage department when the product is designed and to get the confirmation.



For part availability and ordering information please call Toll Free: 800.984.5337 Website: www.marktechopto.com | Email: info@marktechopto.com

Preliminary

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TOSHIBA InGaA{P LED

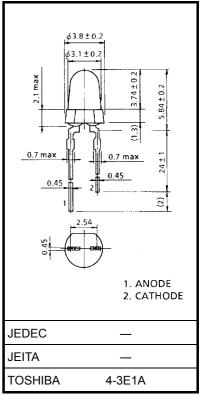
TLRH50T(F),TLSH50T(F),TLOH50T(F),TLYH50T(F)

Panel Circuit Indicators

- Lead(Pb)-free products (lead: Sn-Ag-Cu)
- 3 mm package
- InGaAℓP technology
- All plastic mold type
- Transparent lens
- Line-up: 3 colors (red, orange, yellow)
- High intensity light emission
- Excellent low current light output

Lineup

Product Name	Color	Material			
TLRH50T(F)	Red				
TLSH50T(F)	Red	InGaAℓP			
TLOH50T(F)	Orange	ΠΟάλει			
TLYH50T(F)	Yellow				



Weight: 0.14 g

Unit: mm

Preliminary

Maximum Ratings (Ta = 25°C)

Product Name	Forward Current I _F (mA)	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operating Temperature T _{opr} (°C)	Storage Temperature T _{stg} (°C)		
TLRH50T(F)	SH50T(F) 50 DH50T(F) 50	4		-40~100			
TLSH50T(F)			120		-40~120		
TLOH50T(F)			120	-40~100	-40~120		
TLYH50T(F)							

Electrical and Optical Characteristics (Ta = 25°C)

Product Name	Typ. Emission Wavelength		Luminous Intensity I _V		Forward Voltage VF		Reverse Current I _R					
	λd	λp	Δλ	١ _F	Min	Тур.	١ _F	Тур.	Max	١ _F	Max	VR
TLRH50T(F)	630	(644)	13	20	850	2000	20	1.9	2.4	20	50	4
TLSH50T(F)	613	(623)	13	20	2720	4700	20	2.0	2.4	20	50	4
TLOH50T(F)	605	(612)	13	20	1530	5800	20	2.0	2.4	20	50	4
TLYH50T(F)	587	(590)	13	20	1530	4400	20	2.0	2.4	20	50	4
Unit		nm		mA	m	cd	mA	١	/	mA	μA	V

Precautions

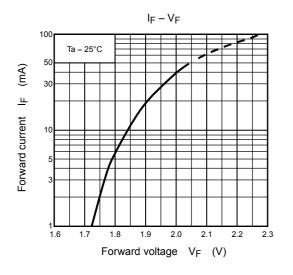
Please be careful of the following:

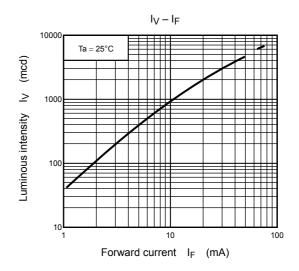
- Soldering temperature: 260°C max, soldering time: 3 s max (Soldering portion of lead: up to 1.6 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 1.6 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

TLRH50T(F),TLSH50T(F),TLOH50T(F),TLYH50T(F)

TLRH50T(F)

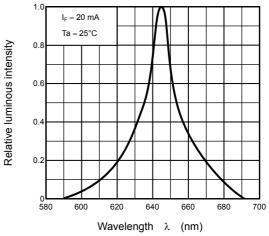
Preliminary



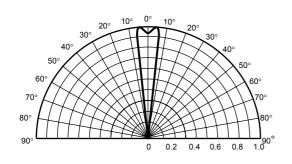


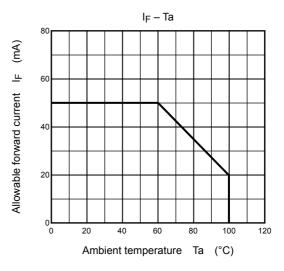
 V_{-Tc} $I_{V} - Tc$ $I_{V} - Tc$ $I_{$

Relative luminous intensity - Wavelength



Radiation pattern

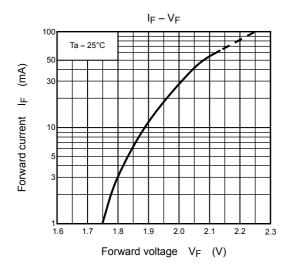


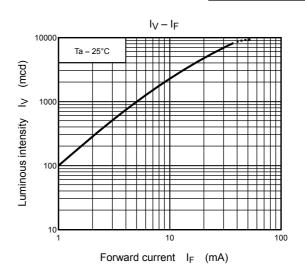


TLRH50T(F),TLSH50T(F),TLOH50T(F),TLYH50T(F)

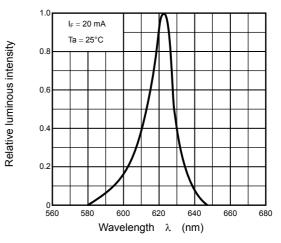
TLSH50T(F)

Preliminary

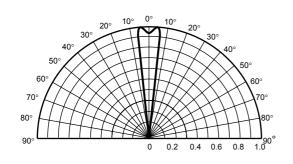


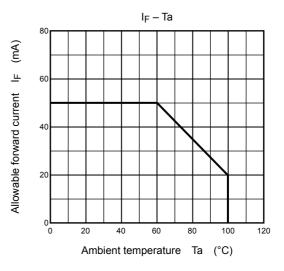


Relative luminous intensity - Wavelength



Radiation pattern

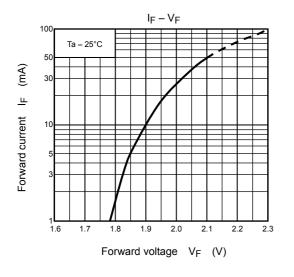


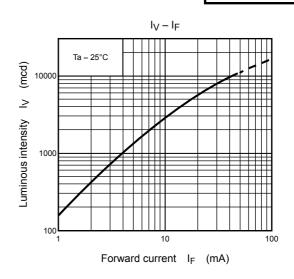


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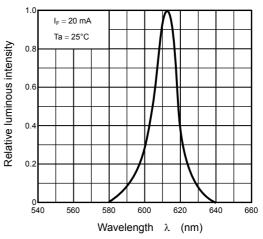
TLOH50T(F)

Preliminary

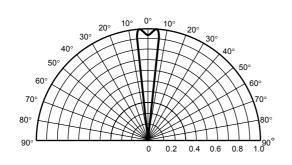


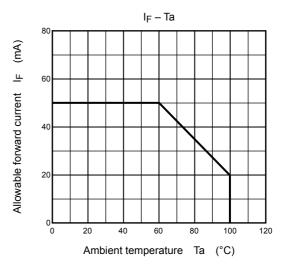


Relative luminous intensity - Wavelength



Radiation pattern

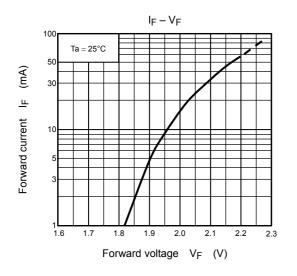


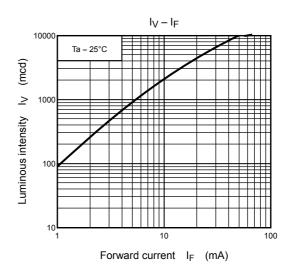


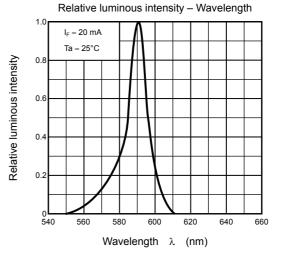
TLRH50T(F),TLSH50T(F),TLOH50T(F),TLYH50T(F)

TLYH50T(F)

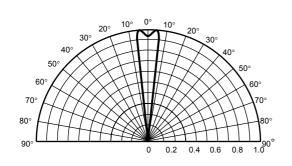
Preliminary

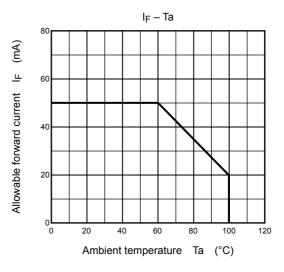






Radiation pattern





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000707EAC

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